

CBR06C909BAGAC

CBR-SMD RF COG, Ceramic, 9 pF, +/-0.1 pF, 250 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603



Click here for the 3D model.

Dimensions		
Chip Size	0603	
L	1.6mm +/-0.1mm	
W	0.8mm +/-0.1mm	
Т	0.8mm +/-0.07mm	
В	0.4mm +/-0.15mm	

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	5.6 mg
Notes	Solder Wave or Solder Reflow.
Shelf Life	78 Weeks
MSL	1

Specifications				
9 pF				
+/-0.1pF				
250 VDC				
500 VDC				
-55/+125°C				
COG				
0.172%				
0% Loss/Decade Hour				
10 GOhms				
580				

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.